



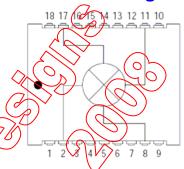
#### **Product Features**

- +36 dBm IIP3
- No External Matching Elements Required
- RF 1700-1880 MHz
- LO 1550-1830 MHz
- IF 50 150 MHz
- +17 dBm LO Drive Level
- +3V Bias (18 mA)
- Low Cost SMT J-Lead Package

#### **Product Description**

The HMJ4 is a high dynamic range GaAs FET mixer. This active FET mixer realizes a typical third order intercept point of +36 dBm at an LO drive level of +17 dBm. The HMJ4 comes in a low cost, 18-pin J-Lead package. Typical applications include frequency up/down conversion, modulation and demodulation for receivers and transmitters used in communications systems.

#### **Functional Diagram**



	Function	Pin No.
		2
	750	11
4	RF	17
Q	+3V	8
	Ground	All other pins

## **Specifications** (1)

Parameter	Units	Min Typ Max Condition
RF Frequency Range	MHz	1700-1880
LO Frequency Range	MHz	1550-1830
IF Frequency Range	MHz	50 – 150
SSB Conversion Loss	dB	8.80 9.4
Noise Figure	dB	
LO-RF Isolation	dB	18 34 00
LO-IF Isolation	dB	23 ( ) 33
RF-IF Isolation	dB	14
Input IP3	dBm	31 36
RF Return Loss	dB	
LO Return Loss	dB	
IF Return Loss	dB	15
Input P1dB	dBm	$\langle 20 \rangle$
LO Drive Level	dBm	Y
DC Current at +3V Bias	(nA)	18 30

1. Test conditions unless otherwise noted: 25 % RR = 1800 MHz @ -10 dBm, LO = 1700 MHz @ +17 dBm, IF = 100 MHz

## Absolute Maximum Rating

Parameters (10)	Rating
Operating Case Temperature	-40 to +85 °C
Storage Temperature	-65 to +100 °C
Maximum Input Power	+25 dBm

## **Ordering Information**

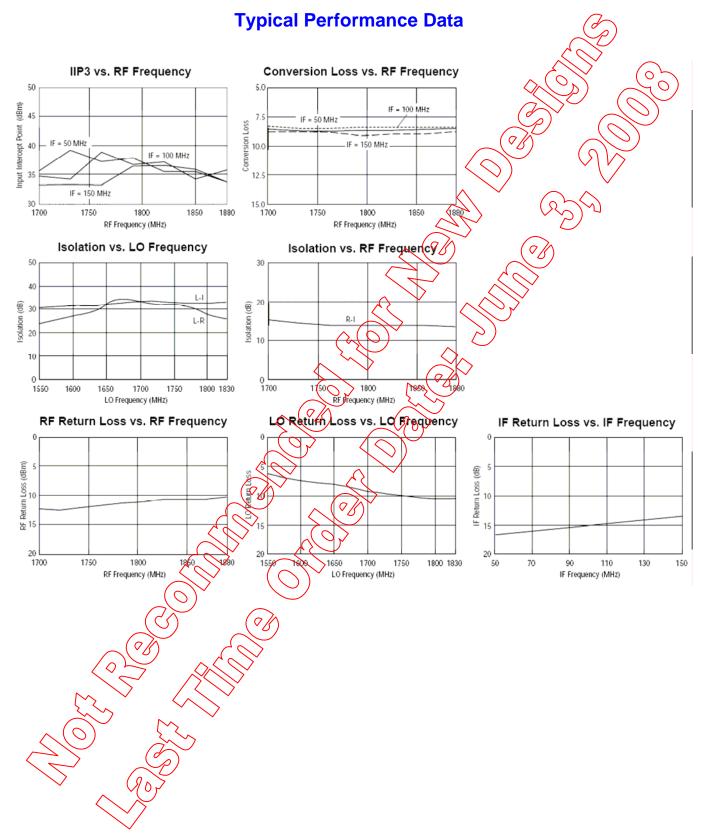
Part No.	Description
HMJ4	High Dynamic Range FET Mixer
HMJ4-PCB	Fully Assembled Application Circuit
-	

<sup>1.</sup> Operation of this device above any of these parameters may cause permanent damage.

<sup>2.</sup> Total sum of LO port and RF port power should not exceed 25 dBm



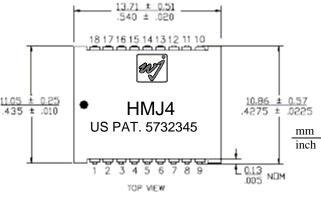


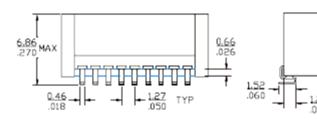












Land Pattern / Mounting Configuration

#### **Product Marking**

The component will be marked with an designator with a four-digit alphanumeric lot number XXXX.

Tape and reel specifications for this part are located on the website in the "Application Notes" section.

# ESD Information

ution! ESD sensitive device.

Class 2 ESD Rating: Passes at 2000 V Walue:

Test: Human Body Model (HBM) JEDEC Standard JESD22-A114 Standard:

Class IV ESD Rating

Value: Passes at 2000 V

Charged Device Model (CDM) Test: Standard: JEDEC Standard JESD22-C101

## Mounting Config. Notes

Ground vias are critical for thermal and RF grounding

A minimum of 28 ground vias are required for 14 mil FR4

- If your PCB design rules allow, ground vias should be placed under the land pattern for better RF performance. Otherwise ground vias should be placed as close to the land pattern as possible.

  4. Trace width depends on the PCB material.

